

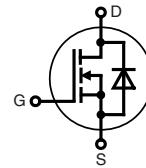
# CoolMOS™<sup>1)</sup> Power MOSFET

N-Channel Enhancement Mode

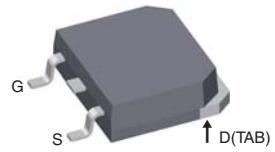
Low  $R_{DS(on)}$ , High  $V_{DSS}$  MOSFET

Ultra low gate charge

$I_{D25}$  = 66 A  
 $V_{DSS}$  = 600 V  
 $R_{DS(on)\ max}$  = 0.045 Ω



TO-268 AA



## MOSFET

| Symbol    | Conditions  | Maximum Ratings |      |  |
|-----------|---|-----------------|------|--|
| $V_{DSS}$ | $T_{VJ} = 25^\circ\text{C}$                                 | 600             | V    |  |
| $V_{GS}$  |   | $\pm 20$        | V    |  |
| $I_{D25}$ | $T_C = 25^\circ\text{C}$                                    | 66              | A    |  |
| $I_{D90}$ | $T_C = 90^\circ\text{C}$                                    | 46              | A    |  |
| $E_{AS}$  | single pulse } $I_D = 11 \text{ A}; T_C = 25^\circ\text{C}$ | 1950            | mJ   |  |
| $E_{AR}$  | repetitive }  | 3               | mJ   |  |
| $dV/dt$   | MOSFET dV/dt ruggedness $V_{DS} = 0 \dots 480 \text{ V}$    | 50              | V/ns |  |

## Symbol Conditions Characteristic Values

( $T_{VJ} = 25^\circ\text{C}$ , unless otherwise specified)

|              |   | min.  | typ. | max. |   |
|--------------|---|---|------|------|---|
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}; I_D = 44 \text{ A}$                                       | 40  | 45   | mΩ   |   |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}; I_D = 3 \text{ mA}$   | 2.5   | 3    | 3.5  | V |
| $I_{DSS}$    | $V_{DS} = 600 \text{ V}; V_{GS} = 0 \text{ V}$                                    | $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$ | 10   | μA   |   |
|              |   |   | 50   | μA   |   |
| $I_{GSS}$    | $V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$                                 |   | 100  | nA   |   |
| $C_{iss}$    | $V_{GS} = 0 \text{ V}; V_{DS} = 100 \text{ V}$                                    | 6800  |      | pF   |   |
| $C_{oss}$    | $f = 1 \text{ MHz}$   | 320   |      | pF   |   |
| $Q_g$        | $V_{GS} = 0 \text{ to } 10 \text{ V}; V_{DS} = 400 \text{ V}; I_D = 44 \text{ A}$ | 150   | 190  | nC   |   |
| $Q_{gs}$     |   | 35  |      | nC   |   |
| $Q_{gd}$     |   | 50  |      | nC   |   |
| $t_{d(on)}$  | $V_{GS} = 10 \text{ V}; V_{DS} = 400 \text{ V}$                                   | 30  |      | ns   |   |
| $t_r$        |   | 20  |      | ns   |   |
| $t_{d(off)}$ |   | 100   |      | ns   |   |
| $t_f$        |   | 10  |      | ns   |   |
| $R_{thJC}$   |   |   | 0.23 | K/W  |   |

## Features

- fast CoolMOS™<sup>1)</sup> power MOSFET 4<sup>th</sup> generation
  - High blocking capability
  - Lowest resistance
  - Avalanche rated for unclamped inductive switching (UIS)
  - Low thermal resistance due to reduced chip thickness
- Enhanced total power density

## Applications

- Switched mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)
- Power factor correction (PFC)
- Welding
- Inductive heating
- PDP and LCD adapter

<sup>1)</sup> CoolMOS™ is a trademark of Infineon Technologies AG.

**Source-Drain Diode**

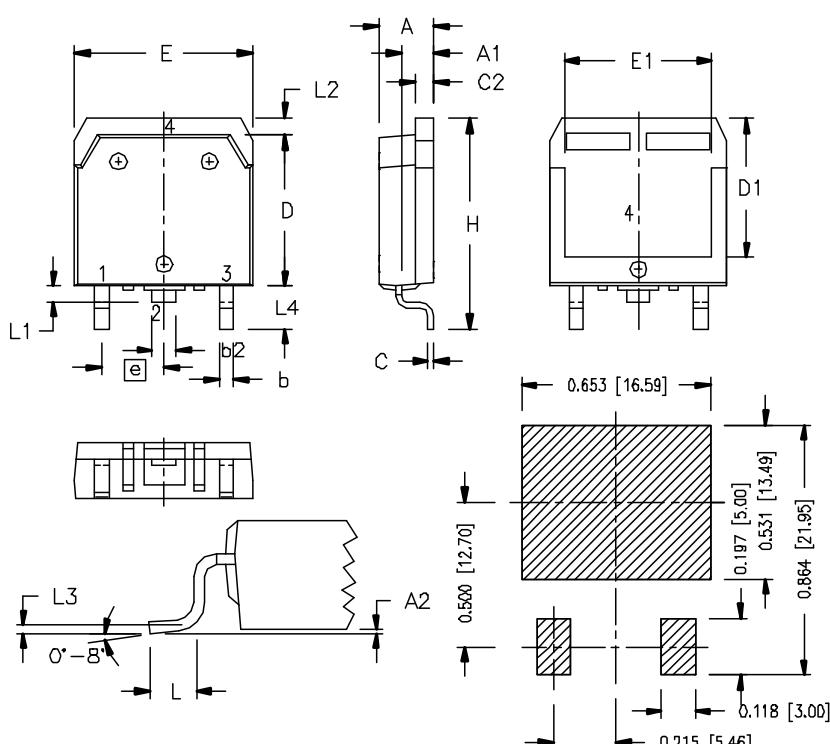
| Symbol                           | Conditions   | Characteristic Values |      |                          |
|----------------------------------|--|-----------------------|------|--------------------------|
|                                  |  | min.                  | typ. | max.                     |
| $I_s$                            | $V_{GS} = 0 \text{ V}$   |                       |      | 44 A                     |
| $V_{SD}$                         | $I_F = 44 \text{ A}; V_{GS} = 0 \text{ V}$   | 0.9                   | 1.2  | V                        |
| $t_{rr}$<br>$Q_{RM}$<br>$I_{RM}$ | $\left. \begin{array}{l} I_F = 44 \text{ A}; -di_F/dt = 100 \text{ A}/\mu\text{s}; V_R = 400 \text{ V} \end{array} \right\}$ | 600<br>17<br>60       |      | ns<br>$\mu\text{C}$<br>A |

**Component**

| Symbol    | Conditions | Maximum Ratings |    |
|-----------|------------|-----------------|----|
| $T_{VJ}$  | operating  | -55...+150      | °C |
| $T_{stg}$ |            | -55...+150      | °C |

| Symbol        | Conditions | Characteristic Values |      |      |
|---------------|------------|-----------------------|------|------|
|               |            | min.                  | typ. | max. |
| <b>Weight</b> |            | 6                     |      | g    |

## TO-247 AD Outline



| SYM | INCHES |      | MILLIMETERS |       |
|-----|--------|------|-------------|-------|
|     | MIN    | MAX  | MIN         | MAX   |
| A   | .193   | .201 | 4.90        | 5.10  |
| A1  | .106   | .114 | 2.70        | 2.90  |
| A2  | .001   | .010 | 0.02        | 0.25  |
| b   | .045   | .057 | 1.15        | 1.45  |
| b2  | .075   | .083 | 1.90        | 2.10  |
| C   | .016   | .026 | 0.40        | 0.65  |
| C2  | .057   | .063 | 1.45        | 1.60  |
| D   | .543   | .551 | 13.80       | 14.00 |
| D1  | .488   | .500 | 12.40       | 12.70 |
| E   | .624   | .632 | 15.85       | 16.05 |
| E1  | .524   | .535 | 13.30       | 13.60 |
| e   | .215   | BSC  | 5.45        | BSC   |
| H   | .736   | .752 | 18.70       | 19.10 |
| L   | .094   | .106 | 2.40        | 2.70  |
| L1  | .047   | .055 | 1.20        | 1.40  |
| L2  | .039   | .045 | 1.00        | 1.15  |
| L3  | .010   | BSC  | 0.25        | BSC   |
| L4  | .150   | .161 | 3.80        | 4.10  |

RECOMMENDED MINIMUM FOOT PRINT FOR SMD

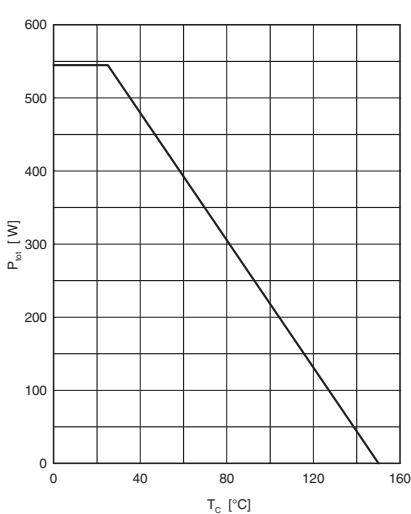


Fig. 1 Power dissipation

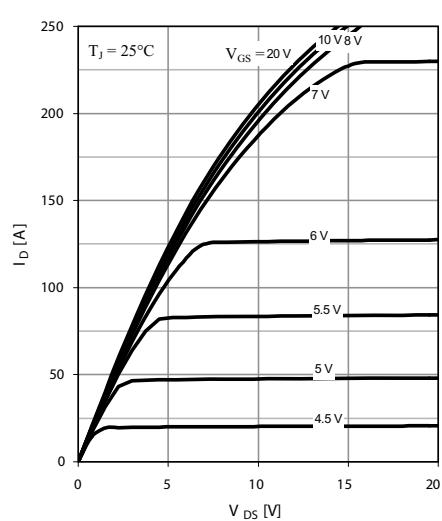


Fig. 2 Typ. output characteristics

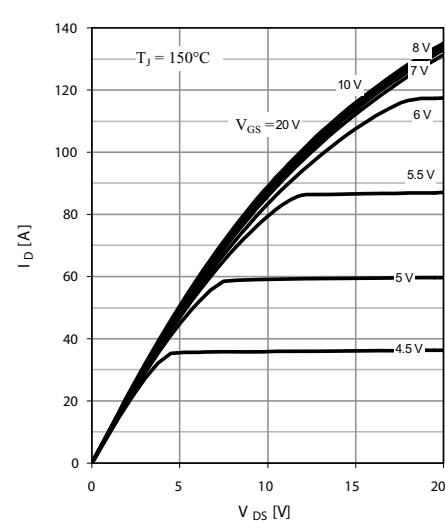


Fig. 3 Typ. output characteristics

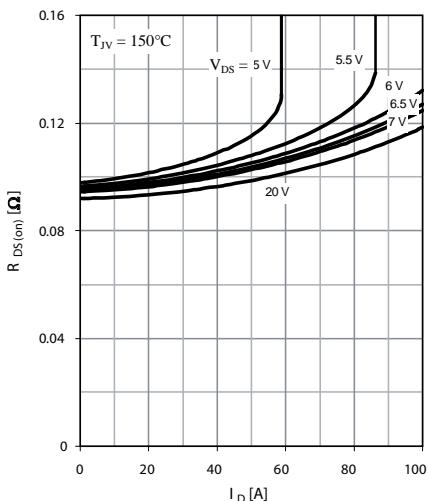


Fig. 4 Typ. drain-source on-state resistance characteristics of IGBT

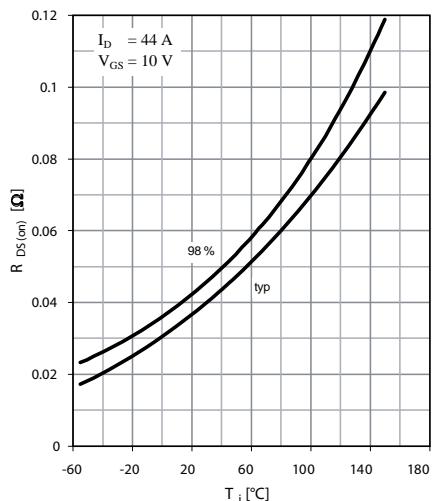


Fig. 5 Drain-source on-state resistance

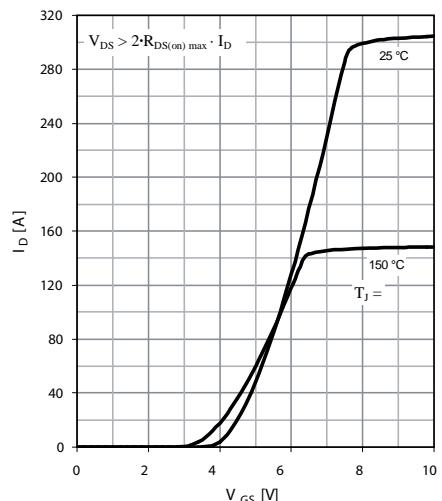


Fig. 6 Typ. transfer characteristics

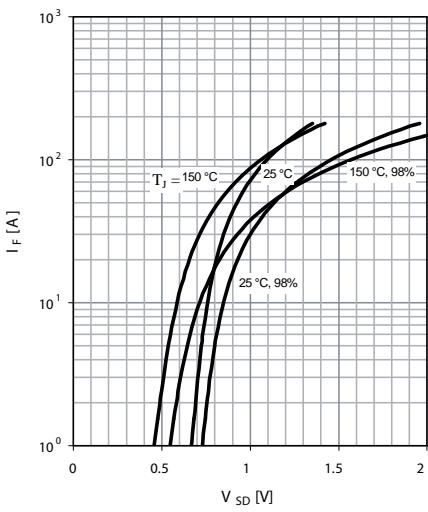


Fig. 7 Forward characteristic of reverse diode

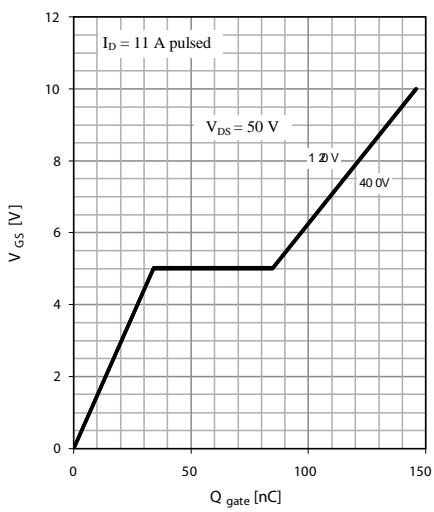


Fig. 8 Typ. gate charge

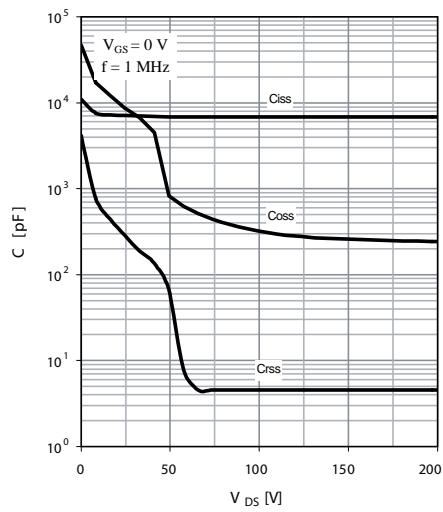


Fig. 9 Typ. capacitances

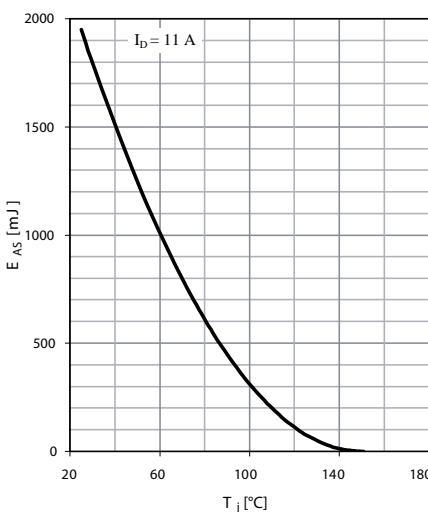


Fig. 10 Avalanche energy

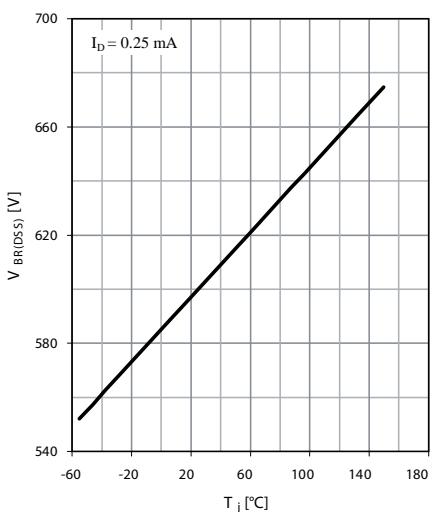


Fig. 11 Drain-source breakdown voltage

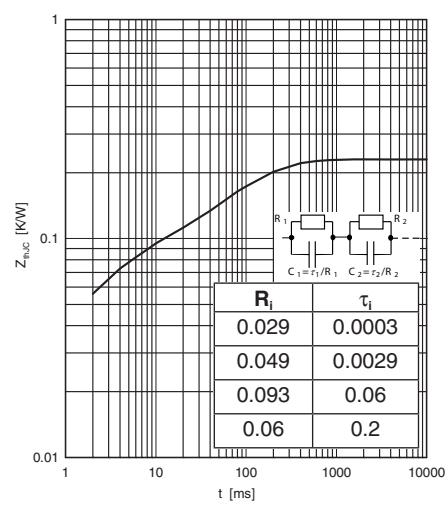


Fig. 12 Max. transient thermal impedance

20090209e

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